19-3799; Rev0; 3/91

CMOS Dual 12-Bit Double-Buffered µP-Compatible DAC

General Description

Maxim's MX7549 is a dual, 12-bit, four-quadrant multiplying, current-output D/A converter (DAC) with 1% DAC-to-DAC matching. Thin-film resistors, laser-trimmed at the wafer level, maintain full accuracy over the operating temperature range. Other features include $\pm 1/2$ LSB maximum integral nonlinearity, ± 3 LSB full-scale error, and ± 5 ppm/°C gain temperature coefficient.

Three address lines controlled by standard CHIP SELECT (CS) and WRITE (WR) signals simplify microprocessor (μ P) interfacing. Each DAC is loaded in three 4-bit nibbles. The UPDATE (UPD) input updates the output of both DACs simultaneously.

All digital inputs are TTL, 74HC, and +5V CMOS compatible. The MX7549 operates from a single +5V to +15V supply and is pin-compatible with the AD7549.

_ Features

- Two 12-Bit, Double-Buffered DACs in One Package
- 4-Bit Microprocessor Interface
- Four-Quadrant Multiplication
- 1% DAC-to-DAC Matching
- ±1/2LSB Max Integral Nonlinearity
- ±3LSB Max Full-Scale Error
- ◆ ±5ppm/°C Max Gain Tempco
- Operates with a Single +5V to +15V Supply
- Pin-Compatible with the AD7549

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE	ERROR (LSBs)
MX7549JN	0°C to +70°C	20 Plastic DIP	±1
MX7549KN	0°C to +70°C	20 Plastic DIP	±1/2
MX7549JCWP	0°C to +70°C	20 Wide SO	±1
MX7549KCWP	0°C to +70°C	20 Wide SO	±1/2
MX7549JP	0°C to +70°C	20 PLCC	±1
MX7549KP	0°C to +70°C	20 PLCC	±1/2
MX7549JC/D	0°C to +70°C	Dice*	±1
MX7549AQ	-40°C to +85°C	20 CERDIP	±1
MX7549BQ	-40°C to +85°C	20 CERDIP	±1/2
MX7549SE	-55°C to +125°C	20 LCC**	±1
MX7549TÉ	-55°C to +125°C	20 LCC**	±1/2
MX7549SQ	-55°C to +125°C	20 CERDIP**	±1
MX7549TQ	-55°C to +125°C	20 CERDIP**	±1/2

*Contact factory for dice specifications.

** Contact factory for availability and processing to MIL-STD-883.



Vod VREFA 201 19 INPUT REGISTER DAC A REGISTER HIGH 18 D3 RFBA MID INPUT BUFFERS DAC A 17 IOUTA D0 , ĪOW CER 11 6 16 AGND A2 CONTROL DECODERS A1 A0 CLR 11 CLR CLR LOW ¹⁵ юлтв MID DAC B NIBBLE 14 RFBB HIGH NIBBLE INPUT REGISTER DAC B REGISTER 13 12 VREER DGND

Functional Diagram

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Applications

Automatic Test Equipment (ATE) Microprocessor-Based Process Control Programmable Power Supplies Programmable Filters

Synchro Applications

/VI/IXI/VI

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ABSOLUTE MAXIMUM RATINGS

V _{DD} to DGND
VREFA to AGND ±25V
VREFB to AGND ±25V
VRFBA to AGND±25V
VRFBB to AGND ±25V
AGND to DGND
Digital Input Voltage to DGND0.3V to V _{DD} +0.3V
Analog Outputs to DGND

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +15V \pm 5\%; VREFA = VREFB = +10V; I_{OUTA} = I_{OUTB} = AGND = DGND = 0V; All Grades; T_A = T_{MIN}$ to T_MAX, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
ACCURACY								
Resolution	N				12			Bits
			J/A/S				±1	LSB
Integral Nonlinearity	INL			K/B/T			±1/2	
DifferentialNonlinearity	DNL	Guaranteed monoton	ic over temperature	,			±1	LSB
E III De ele France				J/A/S			±6	LSB
Full-Scale Error				K/B/T			±3	
Gain Temperature Coefficient (Note 2)	∆Gain/ ∆Temp					±1	±5	ppm/°C
			T _A = +25°C				20	
Output Leakage Current	lout	DAC_Register	TA = TMIN to TMAX	J/K/A/B			150	nA
			S/T			250	L	
Reference Input Resistance					7	11	18	kΩ
VREFA, VREFB Input	VREF			J/A/S		±1	±3	%
Resistance Match	VILL	· K/B/T				±1	±2	
DYNAMIC PERFORMANCE (No	ote 3)							<u> </u>
Output-Current Settling Time (Note 4)	ts		T _A = +25°C			0.8	1.5	μs
AC Feedthrough VREF_ to		·	T _A = +25°C				-70	dB
IOUT_ (Note 5)			TA = TMIN to TMAX				-65	
Digital-to-Analog Glitch Impulse	Q	Note 6	T _A = +25°C			10		(nV)(s
Output Capacitance	Соит	DAC_loaded with all 0's			40	80	Pa	
Output Capacitance		DAC_ loaded with all 1's			ļ	100	160	
Channel-to-Channel Isolation VREF_ to IOUT_		VREFA = 20Vp-p 100kHz sine wave, VREFB = 0V or VREFB = 20Vp-p 100kHz sine wave, VREFA = 0V			ļ	-62		dB
Digital Crosstalk		For code transitions from all 0's to all 1's 10				(nV)(s		
Output-Noise Voltage Density		From RFBA to IOUTA and from RFBB to IOUTB. 15 10Hz to 100kHz.				nV∕√F		
Harmonic Distortion	THD	VIN = 6Vrms 1kHz	VIN = 6Vrms 1kHz -90					dB

MX7549

1111X111

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = +15V \pm 5\%; VREFA = VREFB = +10V; I_{OUTA} = I_{OUTB} = AGND = DGND = 0V; All Grades; T_A = T_{MIN}$ to T_MAX, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DIGITAL INPUTS							_
			T _A = +25°C			±1	
Input Current	liN	$V_{IN} = V_{DD}$	TA = TMIN to TMAX			±10	- μΑ
Input Low Voltage	VIL					0.8	V
Input High Voltage	Viн		-	2.4			V
Input Capacitance (Note 3)	Cin					7	pF
POWER REQUIREMENTS	k						
Power Supply	loo	All digital inputs	at ViH			3	mA
Power-Supply Rejection	<u>∆Gain</u> ∆V _{DD}	V _{DD} = 10.8V to 15.75V			±0.0005	±0.002	%/%

TIMING CHARACTERISTICS

(VDD = +15V, VREFA = VREFB = +10V; IOUTA = IOUTB = AGND = DGND = 0V; All Grades; TA = TMIN to TMAX, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN TYP	MAX	UNITS	
		TA = +25°C		50			
Address Valid to	tı	T. T. M. T.	J/A	75		ns	
Write Setup Time		$T_A = T_{MIN}$ to T_{MAX}	S/T	90			
Address Valid to Write Hold Time	t2			0		ns	
		T _A = +25°C		70			
Data Setup Time	t3	T. T	J/A	95		ns	
		$T_A = T_{MIN}$ to T_{MAX}	S/T	120			
Data Hold Time	t4			0		ns	
Chip Select or Update to Write Setup Time	t5			0		ns	
Chip Select or Update to Write Hold Time	t6			0		ns	
		$T_A = +25^{\circ}C$		50		_	
Write Pulse Width	t7	T T b T	J/A	75		ns	
		$T_A = T_{MIN}$ to T_{MAX}	S/T	90			
		T _A = +25°C		50			
Clear Pulse Width	t8	T. T	J/A	75	n	ns	
		$T_A = T_{MIN}$ to T_{MAX}	S/T	90]	

Note 1: At VDD = +5V, the device is functional with degraded performance. Performance at power-supply tolerance limits is guaranteed by Power-Supply Rejection test. Note 2: Guaranteed by design.

Note 3: These characteristics are for design guidance only and are not subject to test.

Note 4: Measured to 0.01% of full-scale range. I_{OUT} Load = 100 Ω , CEXT = 13pF. DAC output measured from falling edge of WR. Note 5: VREF_ = 20Vp-p 10kHz sine wave. DAC register is loaded with all zeros.

Note 6: Measured with VREFA = VREFB = 0V. IOUTA, IOUTB load = 1000, CEXT = 13pF. DAC registers alternately loaded with all 0's and 1's.

		Pin Description
PIN	NAME	FUNCTION
1	D3	Data Bit 3, 7, or 11 (MSBs)
2	D2	Data Bit 2, 6, or 10
3	D1	Data Bit 1, 5, or 9
4	D0	Data Bit 0, 4, or 8 (LSBs)
5	UPD	UPDATE Input - active low. Up- dates both DAC registers simul- taneously from input registers.
6-8	A2-A0	Address Lines 2 - 0
9	CS	CHIP SELECT Input - active low
10	WR	WRITE Input - active low
11	CLR	CLEAR Input - active high. Clears all registers.
12	DGND	Digital Ground
13	VREFB	Voltage Reference Input to DAC B
14	RFBB	Feedback Resistor for DAC B
15	Іоитв	DAC B Output
16	AGND	Analog Ground
17	Ιουτα	DAC A Output
18	RFBA	Feedback Resistor for DAC A
19	VREFA	Voltage Reference Input to DAC A
20	VDD	Supply Voltage Input

Pin Description

updates DAC A and DAC B registers simultaneously, eliminating one WRITE cycle. All digital inputs incorporate standard protection circuitry and are TTL, 74HC, and +5V CMOS compatible.

D/A Converter

The basic MX7549 circuit includes two identical DACs with laser-trimmed, thin-film (R-2R) arrays with NMOS current-steering switches (Figure 1). Binary-weighted currents switch between AGND and the output, depending on the status of each input data bit.



Figure 1. MX7549 Simplified DAC Schematic

The current output can be converted to a voltage by adding an external output amplifier (Figures 3, 4). The VREF input accepts a wide range of signals, including fixed and time-varying voltage or current inputs. Consider the temperature coefficient of R1 (R3) and R2 (R4) to minimize gain variation with temperature. The internal feedback resistor is compensated with an NMOS switch that matches the NMOS switches used in the R-2R array. This yields excellent supply rejection and gain temperature coefficients.

The output capacitance, $C_{OUT,}$ is code dependent and is typically 40pF with DAC loaded with all zeros, or 100pF with all ones.

Digital Circuit

Logic inputs are TTL, 74HC, and +5V CMOS compatible (0.8V and 2.4V) at $V_{DD} = +12V$ to +15V. DAC supply current can be reduced below specified levels by keeping digital input voltages as close to the logic supply and ground as possible (as with CMOS logic levels).

Detailed Description

The nibble input registers of both DACs share a common 4-bit input buffer. Address inputs A2 - A0 select which DAC will receive a 4-bit nibble from the input data bus. With CS, the address lines, and WR low, the low-nibble (4 least significant bits (LSBs)) from the input buffer transfers to the DAC A low-nibble register (Table 1). The mid- and high-nibbles (4 mid and most significant bits (MSBs)) are then transferred in two additional WRITE cycles, reflecting the subsequent 3-bit address codes. The 4th WRITE cycle transfers the 12-bit data from the DAC A nibble input registers to the DAC A register. The DAC B register is loaded in a similar manner. With CS high, UPD low, and after all nibble input registers are loaded, strobing WR

Table 1. MX7549 Truth Table

CLR	UPD	CS	WR	A2	A1	A 0	FUNCTION
0	х	х	1	Х	Х	х	No data transfer
0	1	1	X	х	Х	х	No data transfer
1	х	х	x	х	×	x	All registers cleared
0	1	ο	T	0	0	0	DAC A low- nibble register loaded from data bus
0	1	0	T	0	0	1	DAC A mid- nibble register loaded from data bus
0	1	0	J	0	1	0	DAC A high- nibble register loaded from data bus
0	1	0	T	0	1	1	DAC A register loaded from nibble registers
0	1	0	T	1	0	0	DAC B low- nibble register loaded from data bus
0	1	0	Ţ	1	0	1	DAC B mid- nibble register loaded from data bus
0	1	0	T	1	1	0	DAC B high- nibble register loaded from data bus
0	1	0	T	1	1	1	DAC B register loaded from nibble registers
0	0	1	T	x	x	x	DAC A and B registers up- dated simul- taneously

Note: X = Don't care

Interface

Figure 2 shows the timing diagram for the MX7549. A2, A1, and A0 select the nibble (low, mid, or high) input registers for DAC A or DAC B (Table 1). Data is transferred on the falling edge of \overline{WR} with \overline{CS} and CLEAR (CLR) low. When loading the high-nibble register, D11 is the MSB of the 4-bit data input. Similarly, D7 is the MSB for the midble input registers are loaded, the appropriate DAC register is selected and the data transferred. When \overline{UPD} and CLR are low and \overline{CS} high, the DAC registers are updated simultaneously when \overline{WR} goes active (low).





___ Applications Unipolar Operation

Figure 3 shows the most common configuration for the MX7549 that is used for unipolar binary operation or two-quadrant multiplication when VIN_ is an AC signal. For full-scale adjustment, load 1's into the DAC A register, and trim R1 until VOUT_ = -VIN(4095/4096). Alternatively, R1-R4 can be omitted, and the reference voltage can be adjusted to compensate for full-scale error. DAC B full-scale errors are trimmed in the same manner.

Capacitors C1 and C2 provide phase compensation. They also reduce overshoot and ringing when fast amplifiers are used at the DAC output. Single or dual op amps can be used in this application.



Figure 3. Dual DAC Unipolar Binary Operation (Two-Quadrant Multiplication)

Table 2.	Unipolar	Binary	Code	Table	for	MX7549	
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DIGITAL INPUT	ANALOG OUTPUT
1111 1111 1111	-V _{IN} 4095 4096
1000 0000 0000	$-V_{\rm IN} \frac{2048}{4096} = -\frac{1}{2} V_{\rm IN}$
0000 0000 0001	$-V_{IN} \frac{1}{4096}$
0000 0000 0000	OV

Note 1: Use R1, R2, R3, and R4 only if gain adjustment is required.

Note 2: C1 and C2 capacitors prevent oscillations when using high-speed amplifiers.

Bipolar Operation

Figure 4 shows bipolar operation (four-quadrant multiplication) using offset-binary code. Adjust zero error as follows: with the appropriate DAC register loaded to 1000 0000 0000, adjust R1 (R3) so VOUTA (VOUTB) = 0V. Alternatively, omit R1 and R2 (R3, R4), and vary R6 and R7 (R9, R10) ratios for VOUTA = 0V. For full-scale trimming, adjust the VIN amplitude, or vary the R5 (R8) value. Select resistors R5, R6, and R7 (R8, R9, R10) so all ratios match to 0.01% and have low-temperature coefficients (e.g. RN-type metal film).

Table 3. Bipolar Binary Code Table for MX7549

DIGITAL INPUT	ANALOG OUTPUT
1111 1111 1111	+V _{IN} 2047 2048
1000 0000 0001	+V _{IN} 1/2048
1000 0000 0000	OV
0111 1111 1111	-V _{IN} 1/2048
0000 0000 0000	$-V_{IN}\frac{2048}{2048} = -V_{IN}$

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Figure 4. Dual DAC Bipolar Offset Binary Operation (Four-Quadrant Multiplication)

Application Hints

Temperature Coefficients

The MX7549 has a maximum gain temperature coefficient (TC) of ±5ppm/°C. If the trim resistors in Figures 3 or 4 are used to adjust full-scale gain error, consider their TC as part of total gain error over the temperature range. Select resistors R5, R6, and R7 (R8, R10, R9) so all ratios match to 0.01% and have low-temperature coefficients (e.g. RN-type metal film).

Digital Feedthrough

The digital inputs to the MX7549 are normally connected directly to the μ P bus. Even when the device is not selected, these inputs will be constantly changing. The

high-frequency logic activity on the bus can feed through the DAC package capacitance to show up as noise on the DAC output. Care should be taken in routing the PC board layout and selecting decoupling components to minimize noise.

Output Amplifier

The output amplifier's offset voltage (Vos) adds to the DAC's nonlinearity. To minimize the effect of Vos and maintain monotonicity, Vos should be less than (25×10^{-6})(VREF) over the operating temperature range. The LF430 has a maximum Vos of 5 μ V over temperature and is ideal for low-bandwidth applications. The LF411 has a 15V/sec slew rate with a wide bandwidth and is recommended for multiplying applications.

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AX7549

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